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**CONFIRMATION NO. 6684** 

SERIAL NUMBER 10/661,372 FILING OR 371(c) DATE 09/12/2003 RULE		CLASS 438		GROUP ART UN 2814		T UNIT	ATTORNEY DOCKET NO. 81751.0065		
APPLICANTS Takahiro Imai, Sakata-city, JAPAN; ** CONTINUING DATA **********************************									
AC None  ** FOREIGN APPLICATIONS ****************************  A C JAPAN 2002-277454 09/24/2002									
IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 01/16/2004									
Foreign Priority claimed  35 USC 119 (a-d) conditions by yes no Met after met  Verified and Acknowledged Examiner's Signature Initials  Acknowledged Interpretation of the priority claimed and priority claimed priority cl					DRAWING CLA		TOTA CLAI 36	MS .	INDEPENDENT CLAIMS 2
ADDRESS 000026021									
TITLE  Method of fabricating stacked semiconductor chips									
RECEIVED	RECEIVED No. to charge/credit DEPOSIT ACCOUNT					☐ All Fees ☐ 1.16 Fees (Filing) ☐ 1.17 Fees (Processing Ext. of time)			
1188	No for following:					1.18 Fees (Issue) Other Credit			